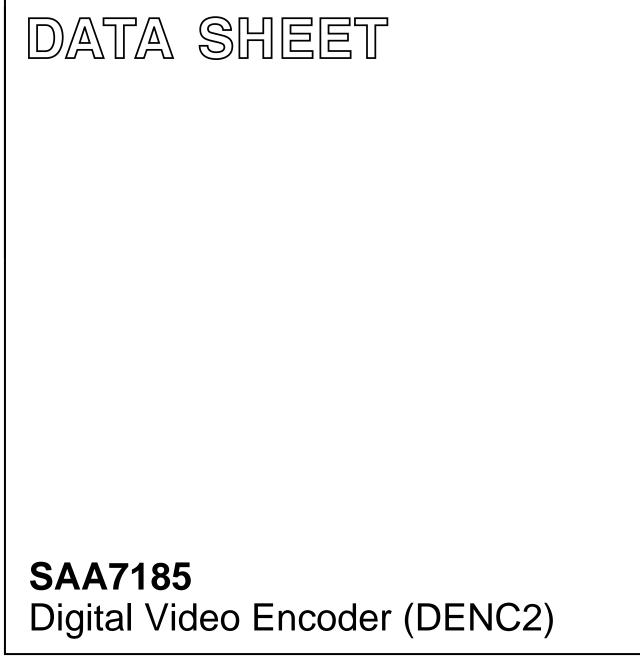
## INTEGRATED CIRCUITS



Preliminary specification Supersedes data of 1995 Jun 15 File under Integrated Circuits, IC02 1996 Jul 08



#### FEATURES

- CMOS 5 V device
- Digital PAL/NTSC encoder
- System pixel frequency 13.5 MHz
- Accepts MPEG decoded data
- 8-bit wide MPEG port
- Input data format Cb, Y, Cr etc. (CCIR 656)
- 16-bit wide YUV input port
- I<sup>2</sup>C-bus control or alternatively MPU parallel control port
- Encoder can be master or slave
- Programmable horizontal and vertical input synchronization phase
- · Programmable horizontal sync output phase
- OSD overlay with Look-Up Tables (LUTs)  $8 \times 3$  bytes
- Colour bar generator
- Line 21 Closed Caption encoder
- Cross-colour reduction
- DACs operating at 27 MHz with 10-bit resolution
- Controlled rise/fall times of output syncs and blanking
- Down-mode of DACs
- CVBS and S-Video output simultaneously
- PLCC68 package.

SYMBOL

#### QUICK REFERENCE DATA

		1			
V <sub>DDA</sub>	analog supply voltage	4.75	5.0	5.25	V
V <sub>DDD</sub>	digital supply voltage	4.5	5.0	5.5	V
I <sub>DDA</sub>	analog supply current	-	50	55	mA
I <sub>DDD</sub>	digital supply current	-	140	170	mA
Vi	input signal voltage levels	ТТ	L compati	ble	
V <sub>o(p-p)</sub>	analog output signal voltages Y, C and CVBS without load (peak-to-peak value)	-	2	-	V
RL	load resistance	80	_	-	Ω
ILE	LF integral linearity error	-	_	±2	LSB
DLE	LF differential linearity error	-	-	±1	LSB
T <sub>amb</sub>	operating ambient temperature	0	-	+70	°C

PARAMETER

**GENERAL DESCRIPTION** 

(DACs).

NTSC, PAL CVBS or S-Video signal.

The SAA7185 encodes digital YUV video data to an

The circuit accepts CCIR compatible YUV data with

The circuit is compatible to the DIG-TV2 chip family.

MIN.

TYP.

MAX.

UNIT

720 active pixels per line in 4 : 2 : 2 multiplexed formats,

for example MPEG decoded data. It includes a sync/clock generator and on-chip Digital-to-Analog Converters

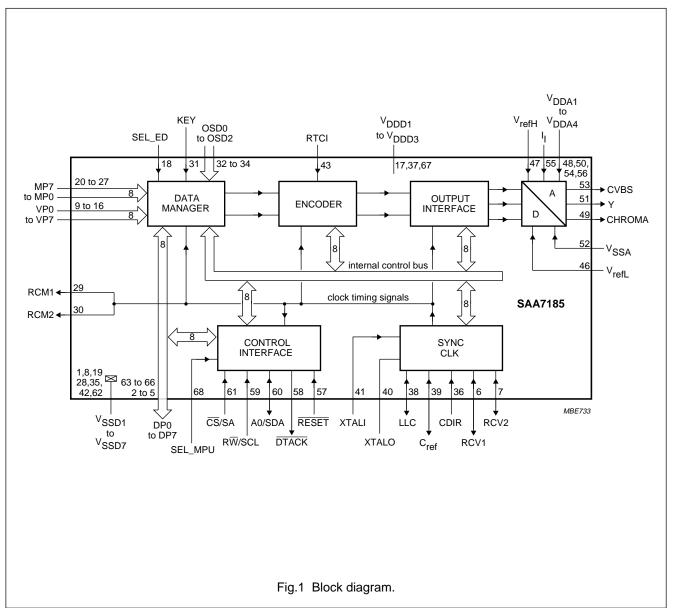


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#### ORDERING INFORMATION

TYPE NUMBER		PACKAGE	
I TPE NUMBER	NAME	DESCRIPTION	VERSION
SAA7185WP	PLCC68	plastic leaded chip carrier; 68 leads	SOT188-2

#### **BLOCK DIAGRAM**



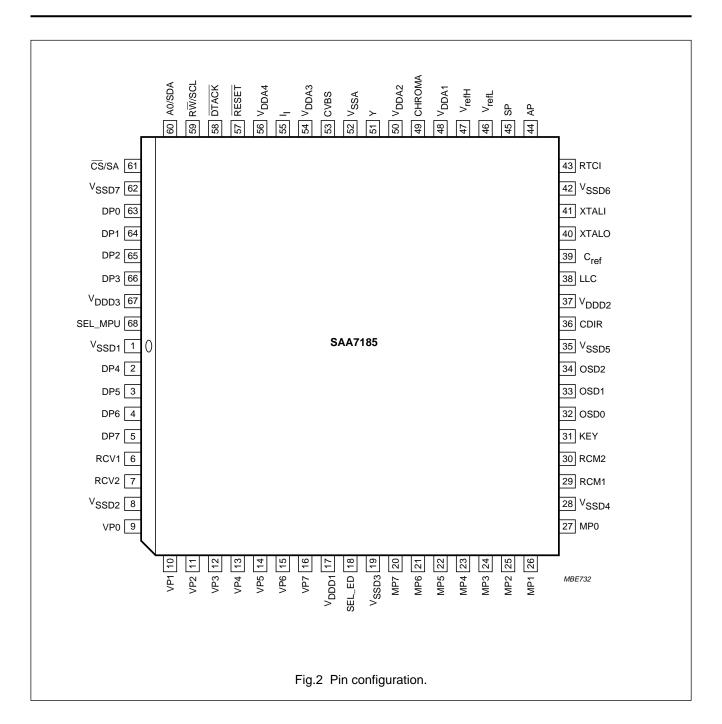
## SAA7185

#### PINNING

SYMBOL	PIN	DESCRIPTION
V <sub>SSD1</sub>	1	digital ground 1
DP4	2	
DP5	3	Upper 4 bits of the Data Port. If pin 68 (SEL_MPU) is HIGH, this is the data bus of the parallel
DP6	4	MPU interface. If it is LOW, they are the UV lines of the Video Port.
DP7	5	
RCV1	6	Raster Control 1 for Video port. Depending on the synchronization mode, this pin receives/provides a VS/FS/FSEQ signal.
RCV2	7	Raster Control 2 for Video port. Depending on the synchronization mode, this pin receives/provides an HS/HREF/CBL signal.
V <sub>SSD2</sub>	8	digital ground 2
VP0	9	
VP1	10	
VP2	11	
VP3	12	Video Port. This is an input for CCIR 656 compatible, multiplexed video data. If the 16-bit
VP4	13	DIG-TV2 format is used, this is the Y data.
VP5	14	
VP6	15	
VP7	16	
V <sub>DDD1</sub>	17	digital supply voltage 1
SEL_ED	18	Select Encoder Data. Selects data either from MPEG port or from video port as encoder input.
V <sub>SSD3</sub>	19	digital ground 3
MP7	20	
MP6	21	
MP5	22	
MP4	23	MDEC Dart. It is an input for CCID 656 atula multiplayed VLIV data
MP3	24	<ul> <li>MPEG Port. It is an input for CCIR 656 style multiplexed YUV data.</li> </ul>
MP2	25	
MP1	26	
MP0	27	
V <sub>SSD4</sub>	28	digital ground 4
RCM1	29	Raster Control 1 for MPEG port. This pin provides a VS/FS/FSEQ signal.
RCM2	30	Raster Control 2 for MPEG port. This pin provides an HS pulse for the MPEG decoder.
KEY	31	Key signal for OSD. It is active HIGH.
OSD0	32	
OSD1	33	On-Screen Display data. This is the index for the internal OSD look-up table.
OSD2	34	
V <sub>SSD5</sub>	35	digital ground 5
CDIR	36	Clock direction. If the CDIR input is HIGH, the circuit receives a clock signal, otherwise LLC and CREF are generated by the internal crystal oscillator.
V <sub>DDD2</sub>	37	digital supply voltage 2

SYMBOL	PIN	DESCRIPTION
LLC	38	Line-Locked Clock. This is the 27 MHz master clock for the encoder. The direction is set by the CDIR pin.
C <sub>ref</sub>	39	Clock Reference signal. This is the clock qualifier for DIG-TV2 compatible signals.
XTALO	40	Crystal oscillator output (to crystal).
XTALI	41	Crystal oscillator input (from crystal). If the oscillator is not used, this pin should br connected to ground.
V <sub>SSD6</sub>	42	digital ground 6
RTCI	43	Real Time Control Input. If the clock is provided by an SAA7151B, RTCI should be connected to the RTCO pin of the decoder to improve the signal quality.
AP	44	Test pin. Connect to digital ground for normal operation.
SP	45	Test pin. Connect to digital ground for normal operation.
V <sub>refL</sub>	46	Lower reference voltage input for the DACs.
V <sub>refH</sub>	47	Upper reference voltage input for the DACs.
V <sub>DDA1</sub>	48	Analog positive supply voltage 1 for the DACs and output amplifiers.
CHROMA	49	Analog output of the chrominance signal.
V <sub>DDA2</sub>	50	Analog supply voltage 2 for the DACs and output amplifiers.
Y	51	Analog output of the luminance signal.
V <sub>SSA</sub>	52	Analog ground for the DACs and output amplifiers.
CVBS	53	Analog output of the CVBS signal.
V <sub>DDA3</sub>	54	Analog supply voltage 3 for the DACs and output amplifiers.
lı	55	Current input for the output amplifiers, connect via a 15 k $\Omega$ resistor to V <sub>DDA</sub> .
V <sub>DDA4</sub>	56	Analog supply voltage 4 for the DACs and output amplifiers.
RESET	57	Reset input, active LOW. After reset is applied, all outputs are in 3-state input mode. The I <sup>2</sup> C-bus receiver waits for the start condition.
DTACK	58	Data acknowledge output of the parallel MPU interface, active LOW, otherwise high impedance.
RW/SCL	59	If pin 68 (SEL_MPU) is HIGH, this is the read/write signal of the parallel MPU interface, otherwise it is the I <sup>2</sup> C-bus serial clock input.
A0/SDA	60	If pin 68 (SEL_MPU) is HIGH, this is the address signal of the parallel MPU interface, otherwise it is the I <sup>2</sup> C-bus serial data input/output.
CS/SA	61	If pin 68 (SEL_MPU) is HIGH, this is the chip select signal of the parallel MPU interface, otherwise it is the I <sup>2</sup> C-bus slave address select pin. LOW: slave address = 88H, HIGH = 8CH.
V <sub>SSD7</sub>	62	digital ground 7
DP0	63	
DP1	64	Lower 4 bits of the Data Port. If pin 68 (SEL_MPU) is HIGH, this is the data bus of the parallel
DP2	65	MPU interface. If it is LOW, they are the UV lines of the Video Port.
DP3	66	
V <sub>DDD3</sub>	67	digital supply voltage 3
SEL_MPU	68	Select MPU interface input. If it is HIGH, the parallel MPU interface is active, otherwise the $I^2$ C-bus interface will be used.





#### FUNCTIONAL DESCRIPTION

The digital MPEG-compatible Video Encoder (DENC2) encodes digital luminance and chrominance into analog CVBS and simultaneously S-Video (Y/C) signals. NTSC-M and PAL B/G standards also sub-standards are supported.

The basic encoder function consists of subcarrier generation and colour modulation also insertion of synchronization signals. Luminance and chrominance signals are filtered in accordance with the standard requirements RS-170-A and CCIR 624.

For ease of analog post filtering the signals are twice oversampled with respect to pixel clock before digital-to-analog conversion.

For total filter transfer characteristics see Figs 3, 4, 5 and 6. The DACs are realized with full 10-bit resolution. The encoder provides three 8-bit wide data ports, that serve different applications.

The MPEG Port (MP) and the Video Port (VP) accept 8 lines multiplexed Cb-Y-Cr data.

The Video Port (VP) is also able to handle DIG-TV2 family compatible 16-bit YUV signals. In this event, the Data Port (DP) is used for the U/V components.

The Data Port can handle the data of an 8-bit wide microprocessor interface, alternatively.

The 8-bit multiplexed Cb-Y-Cr formats are CCIR 656 (D1 format) compatible, but the SAV, EAV etc. codes are not decoded.

A crystal-stable master clock (LLC) of 27 MHz, which is twice the CCIR line-locked pixel clock of 13.5 MHz, needs to be supplied externally. Optionally, a crystal oscillator input/output pair of pins and an on-chip clock driver is provided. Additionally, a DMSD2 compatible clock interface, using  $C_{ref}$  (input or output) and RTC (see "data sheet SAA7151B") is available.

The DENC2 synthesizes all necessary internal signals, colour subcarrier frequency, and synchronization signals, from that clock. DENC2 is always timing master for the MPEG Port (MP), but it can additionally be configured as master or slave for the Video Port (VP).

The IC also contains Closed Caption and Extended Data Services Encoding (Line 21); it also supports OSD via KEY and three-bit overlay techniques by a  $24 \times 8$  LUT.

The IC can be programmed via I<sup>2</sup>C-bus or 8-bit MPU interface, but only one interface configuration can be active at a time; if the 16-bit Video Port mode (VP and DP) is being used, only the I<sup>2</sup>C-bus interface can be selected.

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A number of possibilities are provided for setting of different video parameters such as:

black and blanking level control

colour subcarrier frequency

black variable burst amplitude etc.

During reset ( $\overline{\text{RESET}}$  = LOW) and after reset is released, all digital I/O stages are set to input mode. A reset forces the control interfaces to abort any running bus transfer and to set Register 3AH to contents 13H, Register 61H to contents 0X010101b, and Register 6CH to contents 00H. All other control registers are not influenced by a reset.

#### Data manager

In the Data manager, real time arbitration on the data stream to be encoded is performed.

Depending on hardware conditions (signals on pins SEL\_ED, KEY, OSD2 to OSD0, MP7 to to MP0, VP7 to VP0 and DP7 to DP0) and different software programming either data from the MP port, from the VP port, or from the OSD port are selected to be encoded to CVBS and Y/C signals.

Optionally, the OSD colour look-up tables located in this block, can be read out in a pre-defined sequence (8 steps per active video line), achieving e.g. a colour bar test pattern generator without need for an external data source. The colour bar function is only under software control.

#### Encoder

#### VIDEO PATH

The encoder generates out of Y, U and V baseband signals luminance and colour subcarrier output signals, suitable for use as CVBS or separate Y/C signals.

Luminance is modified in gain and in offset (latter programmable in a certain range to enable different black level set-ups). After having been inserted a fixed synchronization level, in accordance with standard composite synchronization schemes, a variable blanking level, programmable also in a certain range, is inserted.

In order to enable easy analog post filtering, luminance is interpolated from 13.5 MHz data rate to 27 MHz data rate, providing luminance in 10-bit resolution. This filter is also used to define smoothed transients for synchronization pulses and blanking period. For transfer characteristic of the luminance interpolation filter see Figs 5 and 6.

Chrominance is modified in gain (programmable separately for U and V), standard dependent burst is inserted, before baseband colour signals are interpolated from 6.75 MHz data rate to 27 MHz data rate. One of the interpolation stages can be bypassed, thus providing a higher colour bandwidth, which can be made use of for Y/C output. For transfer characteristics of the chrominance interpolation filter see Figs 3 and 4.

The amplitude of inserted burst is programmable in a certain range, suitable for standard signals and for special effects. Behind the succeeding quadrature modulator, colour in 10-bit resolution is provided on subcarrier.

The numeric ratio between Y and C outputs is in accordance with set standards.

#### CLOSED CAPTION ENCODER

Using this circuit, data in accordance with the specification of Closed Caption or Extended Data Service, delivered by the control interface, can be encoded (Line 21). Two dedicated pairs of bytes (two bytes per field), each pair preceded by run-in clocks and framing code, are possible.

The actual line number where data is to be encoded in, can be modified in a certain range.

Data clock frequency is in accordance with definition for NTSC-M standard 32 times horizontal line frequency.

Data LOW at the output of the DACs corresponds to 0 IRE, data HIGH at the output of the DACs corresponds to approximately 50  $\Omega$ .

It is also possible to encode Closed Caption Data for 50 Hz field frequencies at 32 times horizontal line frequency.

#### **Output Interface**

In the output interface encoded Y and C signals are converted from digital-to-analog in 10-bit resolution both Y and C signals are combined to a 10-bit CVBS signal, also; in front of the summation point, the luminance signal can optionally be fed through a further filter stage, suppressing components in the range of subcarrier frequency. Thus, a type of Cross Colour reduction is provided, which is useful in a standard TV set with CVBS input.

Slopes of synchronization pulses are not affected with any Cross Colour reduction active.

Three different filter characteristics or bypass are available, see Fig.5.

The CVBS output occurs with the same processing delay as the Y and C outputs. Absolute amplitudes at the input of the DAC for CVBS is reduced by  $^{15}/_{16}$  with respect to Y and C DACs to make maximum use of conversion ranges.

Outputs of all DACs can be set together via software control to minimum output voltage for either purpose.

#### Synchronization

The synchronization of the DENC2 is able to operate in two modes; slave mode and master mode.

In the slave mode, the circuit accepts synchronization pulses at the bidirectional RCV1 port. The timing and trigger behaviour related to the video signal on VP (and DP, if used) can be influenced by programming the polarity and on-chip delay of RCV1. Active slope of RCV1 defines the vertical phase and optionally the odd/even and colour frame phase to be initialized, it can be also used to set the horizontal phase.

If the horizontal phase is not be influenced by RCV1, a horizontal pulse needs to be supplied at the RCV2 pin. Timing and trigger behaviour can also be influenced for RCV2.

If there are missing pulses at RCV1 and/or RCV2, the time base of DENC2 runs free, thus an arbitrary number of synchronization slopes may miss, but no additional pulses (such with wrong phase) must occur.

If the vertical and horizontal phase is derived from RCV1, RCV2 can be used for horizontal or composite blanking input or output.

In the master mode, the time base of the circuit continuously runs free. On the RCV1 port, the IC can output:

- A Vertical Sync signal (VS) with 3 or 2.5 lines duration, or
- An ODD/EVEN signal which is LOW in odd fields, or
- A field sequence signal (FSEQ) which is HIGH in the first of 4 respectively 8 fields.

On the RCV2 port, the IC can provide a horizontal pulse with programmable start and stop phase; this pulse can be inhibited in the vertical blanking period to build up e.g. a composite blanking signal.

The phase of the pulses output on RCV1 or RCV2 are referenced to the VP port, polarity of both signals is selectable.

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The DENC2 is **always** the timing master for the source at the MP input. The IC provides two signals for synchronizing this source:

On the RCM1 port the same signals as on RCV1 (as output) are available; on RCM2 the IC provides a horizontal pulse with programmable start and stop phase.

The length of a field also start and end of its active part can be programmed. The active part of a field always starts at the beginning of a line.

#### Control interface

DENC2 contains two control interfaces: an I<sup>2</sup>C-bus slave transceiver and 8-bit parallel microprocessor interface. The interfaces cannot be used simultaneously.

The I<sup>2</sup>C-bus interface is a standard slave transceiver, supporting 7-bit slave addresses and 100 kbits/s guaranteed transfer rate. It uses 8-bit subaddressing with an auto-increment function. All registers are write only, except one readable status byte.

Two I<sup>2</sup>C-bus slave addresses can be selected (pin SEL\_MPU must be LOW):

88H: LOW at pin 61

8CH: HIGH at pin 61.

The parallel interface is defined by:

D7 to D0 data bus

CS active-LOW chip select signal

RW read/not write signal, LOW for a write cycle

DTACK 680xx style data acknowledge (handshake), active-LOW

A0 register select, LOW selects address, HIGH selects data.

The parallel interface uses two registers, one auto-incremental containing the current address of a control register (equals subaddress with I<sup>2</sup>C-bus control), one containing actual data. The currently addressed register is mapped to the corresponding control register.

The status byte can be read optionally via a read access to the address register, no other read access is provided.

#### Input levels and formats

DENC2 expects digital YUV data with levels (digital codes) in accordance with CCIR 601.

Deviating amplitudes of the colour difference signals can be compensated by independent gain control setting, while gain for luminance is set to predefined values, distinguishable for 7.5 IRE set-up or without set-up.

The MPEG port accepts only 8-bit multiplexed CCIR 656 compatible data.

If the I<sup>2</sup>C-bus interface is used, the VP port can handle both formats, 8-bit multiplexed Cb-Y-Cr data on the VP lines, or the 16-bit DTV2 format with the Y signal on the VP lines and the UV signal on the DP port.

Reference levels are measured with a colour bar, 100% white, 100% amplitude and 100% saturation.

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Table 1	CCIR signal component levels

SIGNAL	IRE	DIGITAL LEVEL	CODE
	0	16	
Y	50	126	straight binary
	100	235	
	bottom peak	16	
Cb	colourless	128	straight binary
	top peak	240	
	bottom peak	16	
Cr	colourless	128	straight binary
	top peak	240	

#### Table 2 8-bit multiplexed format (similar to CCIR 656)

TIME	0	1	2	2	4	5	6	7
Sample	Cb <sub>0</sub>	Y <sub>0</sub>	Cr <sub>0</sub>	Cr <sub>0</sub> Y <sub>1</sub>		Y <sub>2</sub>	Cr <sub>2</sub>	Y <sub>3</sub>
Luminance pixel number	0		1		2		3	
Colour pixel number		(	)				2	

#### Table 3 16-bit multiplexed format (DTV2 format)

ТІМЕ	0	1	2	3	4	5	6	7
Sample Y line	Y	0	Y	, 1	Y	′2	Y	<b>3</b>
Sample UV line	Cb <sub>0</sub>		Cr <sub>0</sub>		Cb <sub>2</sub>		Cr <sub>2</sub>	
Luminance pixel number	(	)	1		2		3	
Colour pixel number		(	)				2	

Table 4         Slave Receiver (Slave Address 88H or 8CH)	Address 88H o	r 8CH)							
	SUB				DATA BYI	DATA BYTE (note 1)			
	ADDRESS	D7	D6	D5	D4	D3	D2	Б	DO
Null	00	0	0	0	0	0	0	0	0
	$\rightarrow$								
Null	39	0	0	0	0	0	0	0	0
Input port control	3A	CBENB	0	0	V656	VY2C	VUV2C	MY2C	MUV2C
OSD LUT Y0	42	OSDY07	OSDY06	OSDY05	OSDY04	OSDY03	OSDY02	OSDY01	OSDY00
OSD LUT U0	43	OSDU07	OSDU06	OSDU05	OSDU04	OSDU03	OSDU02	OSDU01	00DDO0
OSD LUT V0	44	OSDV07	OSDV06	OSDV05	OSDV04	OSDV03	OSDV02	OSDV01	OSDV00
	$\rightarrow$					_			
OSD LUT Y7	57	OSDY77	OSDY76	OSDY75	OSDY74	OSDY73	OSDY72	OSDY71	OSDY70
OSD LUT U7	85	OSDU77	92NDSO	OSDU75	OSDU74	0SDU73	OSDU72	0SDU71	02DU70
OSD LUT V7	59	OSDV77	OSDV76	OSDV75	OSDV74	OSDV73	OSDV72	OSDV71	OSDV70
Chrominance phase	5A	CHPS7	CHPS6	CHPS5	CHPS4	CHPS3	CHPS2	CHPS1	CHPS0
Gain U	5B	<b>GAINU7</b>	<b>GAINU6</b>	<b>GAINU5</b>	GAINU4	GAINU3	GAINU2	GAINU1	GAINUO
Gain V	5C	<b>GAINV7</b>	GAINV6	GAINV5	GAINV4	GAINV3	GAINV2	GAINV1	GAINVO
Gain U MSB, black level	2D	GAINU8	0	<b>BLCKL5</b>	BLCKL4	<b>BLCKL3</b>	<b>BLCKL2</b>	<b>BLCKL1</b>	BLCKL0
Gain V MSB, blanking level	3E	GAINV8	0	<b>BLNNL5</b>	BLNNL4	<b>BLNNL3</b>	<b>BLNNL2</b>	<b>BLNNL1</b>	<b>BLNNL0</b>
Null	5F	0	0	0	0	0	0	0	0
Cross-colour select	09	CCRS1	CCRS0	0	0	0	0	0	0
Standard control	61	0	DOWN	INP11	YGS	RTCE	SCBW	PAL	FISE
Burst amplitude	62	SQP	BSTA6	BSTA5	BSTA4	<b>BSTA3</b>	BSTA2	BSTA1	BSTA0
Subcarrier 0	63	FSC07	FSC06	FSC05	FSC04	FSC03	FSC02	FSC01	FSC00
Subcarrier 1	64	FSC15	FSC14	FSC13	FSC12	FSC11	FSC10	FSC09	FSC08
Subcarrier 2	65	FSC23	FSC22	FSC21	FSC20	FSC19	FSC18	FSC17	FSC16
Subcarrier 3	99	FSC31	FSC30	FSC29	FSC28	FSC27	FSC26	FSC25	FSC24
Line 21 odd 0	67	L21007	L21006	L21005	L21004	L21003	L21002	L21001	L21000
Line 21 odd 1	68	L21017	L21016	L21015	L21014	L21013	L21012	L21011	L21010
Line 21 even 0	69	L21E07	L21E06	L21E05	L21E04	L21E03	L21E02	L21E01	L21E00
Line 21 even 1	6A	L21E17	L21E16	L21E15	L21E14	L21E13	L21E12	L21E11	L21E10
Encoder control, CC line	6B	MODIN1	MODINO	0	SCCLN4	<b>SCCLN3</b>	SCCLN2	SCCLN1	SCCLNO

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Bit allocation map

DECISTED ELINCTION	SUB				DATA BY1	DATA BYTE (note 1)			
	ADDRESS	D7	D6	D5	D4	D3	D2	5	DO
RCV port control	ပ္ခ	SRCV11	SRCV10	TRCV2	ORCV1	PRCV1	CBLF	ORCV2	PRCV2
RCM, CC mode	6D	0	0	0	0	SRCM11	SRCM10	CCEN1	CCENO
Horizontal trigger	6E	HTRIG7	HTRIG6	HTRIG5	HTRIG4	HTRIG3	HTRIG2	HTRIG1	HTRIG0
Horizontal trigger	6F	0	0	0	0	0	HTRIG10	HTRIG09	HTRIG08
f <sub>sc</sub> reset mode, Vertical trigger	70	PHRES1	PHRESO	SBLBN	VTRIG4	VTRIG3	VTRIG2	VTRIG1	<b>VTRIGO</b>
Begin MP request	71	BMRQ7	<b>BMRQ6</b>	BMRQ5	BMRQ4	<b>BMRQ3</b>	BMRQ2	BMRQ1	BMRQ0
End MP request	72	EMRQ7	EMRQ6	EMRQ5	EMRQ4	EMRQ3	EMRQ2	EMRQ1	EMRQ0
MSBs MP request	73	0	EMRQ10	EMRQ09	EMRQ08	0	BMRQ10	BMRQ09	BMRQ08
Null	74	0	0	0	0	0	0	0	0
Null	75	0	0	0	0	0	0	0	0
Null	76	0	0	0	0	0	0	0	0
Begin RCV2 output	77	BRCV7	BRCV6	BRCV5	BRCV4	BRCV3	BRCV2	BRCV1	<b>BRCV0</b>
End RCV2 output	78	ERCV7	ERCV6	ERCV5	ERCV4	ERCV3	ERCV2	ERCV1	ERCV0
MSBs RCV2 output	79	0	ERCV10	ERCV09	ERCV08	0	BRCV10	BRCV09	BRCV08
Field length	۲A	FLEN7	FLEN6	FLEN5	FLEN4	FLEN3	<b>FLEN2</b>	FLEN1	FLENO
First active line	7B	FAL7	FAL6	FAL5	FAL4	FAL3	FAL2	FAL1	FAL0
Last active line	7C	LAL7	LAL6	LAL5	LAL4	LAL3	LAL2	LAL1	LAL0
MSBs field control	7D	0	0	LAL8	FAL8	0	0	FLEN9	FLEN8
Note									

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1. All bits labelled '0' are reserved. They must be programmed with logic 0.

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#### I<sup>2</sup>C-bus format

Table 5         I <sup>2</sup> C-bus addres	ss; see Table 6
---	-----------------

S SLAVE ADDRESS ACK SUBADDRESS ACK DATA 0 ACK DATA n ACK P	S	SLAVE ADDRESS	ACK	SUBADDRESS	ACK	DATA 0	ACK		DATA n	ACK	Р
--	---	---------------	-----	------------	-----	--------	-----	--	--------	-----	---

#### **Table 6**Explanation of Table 5

PART	DESCRIPTION	
S	START condition	
Slave address	1 0 0 0 1 0 0 X or 1 0 0 0 1 1 0 X (note 1)	
ACK	acknowledge, generated by the slave	
Subaddress (note 2)	subaddress byte	
DATA	data byte	
	continued data bytes and ACKs	
Р	STOP condition	

#### Notes

- 1. X is the read/write control bit; X = logic 0 is order to write; X = logic 1 is order to read, no subaddressing with read.
- 2. If more than 1 byte DATA is transmitted, then auto-increment of the subaddress is performed.

#### **Slave Receiver**

Table 7 Subaddress 3A

DATA BYTE	LOGIC LEVEL	DESCRIPTION
MUV2C	V2C 0 Cb/Cr data at MP are two's complement.	
	1	Cb/Cr data at MP are straight binary. Default after reset.
MY2C	0	Y data at MP are two's complement.
	1	Y data at MP are straight binary. Default after reset.
VUV2C	0	Cb/Cr data input to VP or DP are two's complement. Default after reset.
1 Cb/Cr data input to VP or DP are straight binary.		Cb/Cr data input to VP or DP are straight binary.
VY2C         0         Y data input to VP are two's complement. Default after reset.           1         Y data input to VP are straight binary.		Y data input to VP are two's complement. Default after reset.
		Y data input to VP are straight binary.
V656	0	Selects YUV 422 format on VP (8 lines Y) and DP (8 lines multiplexed Cb/Cr).
	1	Selects CCIR 656 compatible format on VP (8 lines Cb, Y, Cr). Default after reset.
CBENB         0         Data from input ports are encoded. Default after reset.           1         Colour bar with programmable colours (entries of OSD_LUTs) is of The LUTs are read in upward order from index 0 to index 7.		Data from input ports are encoded. Default after reset.
		Colour bar with programmable colours (entries of OSD_LUTs) is encoded. The LUTs are read in upward order from index 0 to index 7.

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#### Table 8Subaddress 42 to 59

		DATA BYTE (note 1	)		
COLOUR	OSDY	OSDU	OSDV	<b>INDEX</b> (note 2)	
White	107 (6BH)	0 (00H)	0 (00H)	0	
	107 (6BH)	0 (00H)	0 (00H)		
Yellow	82 (52H)	144 (90H)	18 (12H)	1	
	34 (22H)	172 (ACH)	14 (0Eh)		
Cyan	42 (2AH)	38 (26H)	144 (90H)	2	
	03 (03H)	29 (1DH)	172 (ACH)		
Green	17 (11H)	182 (B6H)	162 (A2H)	3	
	240 (F0H)	200 (C8H)	185 (B9H)		
Magenta	234 (EAH)	74 (4AH)	94 (5EH)	4	
	212 (D4H)	56 (38H)	71 (47H)		
Red	209 (D1H)	218 (DAH)	112 (70H)	5	
	193 (C1H)	227 (E3H)	84 (54H)		
Blue	169 (A9H)	112 (70H)	238 (EEH)	6	
	163 (A3H)	84 (54H)	242 (F2H)		
Black	144 (90H)	0 (00H)	0 (00H)	7	
	144 (90H)	0 (00H)	0 (00H)		

#### Notes

Contents of OSD Look-up tables. All 8 entries are 8-bits. Data representation is in accordance with CCIR 601 (Y, Cb, Cr), but two's complement, e.g. for a <sup>100</sup>/<sub>100</sub> (upper number) or <sup>100</sup>/<sub>75</sub> (lower number) colour bar.

2. For normal colour bar with CBENB = logic 1.

#### Table 9Subaddress 5A

DATA BYTE	DESCRIPTION
CHPS	Phase of encoded colour subcarrier (including burst) relative to horizontal sync. Can be adjusted in steps of 360/256 degrees.

#### Table 10 Subaddress 5B and 5D

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
GAINU	variable gain for Cb signal;	white-to-black = 92.5 IRE <sup>(1)</sup>	
	input representation accordance with CCIR 601	GAINU = 0	output subcarrier of U contribution = 0
		GAINU = 118 (76H)	output subcarrier of U contribution = nominal
		white-to-black = 100 IRE <sup>(2)</sup>	
		GAINU = 0	output subcarrier of U contribution = 0
		GAINU = 125 (7DH)	output subcarrier of U contribution = nominal

#### Notes

- 1. GAINU =  $-2.17 \times \text{nominal to } +2.16 \times \text{nominal.}$
- 2. GAINU =  $-2.05 \times \text{nominal to } +2.04 \times \text{nominal.}$

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#### Table 11 Subaddress 5C and 5E

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
GAINV	variable gain for Cr signal;	white-to-black = 92.5 IRE <sup>(1)</sup>	
	input representation accordance with CCIR 601	GAINV = 0	output subcarrier of V contribution = 0
		GAINV = 165 (A5H)	output subcarrier of V contribution = nominal
		white-to-black = 100 IRE <sup>(2)</sup>	
		GAINV = 0	output subcarrier of V contribution = 0
		GAINV = 175 (AFH)	output subcarrier of V contribution = nominal

#### Notes

- 1. GAINV =  $-1.55 \times$  nominal to  $+1.55 \times$  nominal.
- 2. GAINV =  $-1.46 \times$  nominal to  $+1.46 \times$  nominal.

#### Table 12 Subaddress 5D

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
BLCKL	variable black level; input	white-to-sync = 140 IRE <sup>(1)</sup>	
	representation accordance with CCIR 601	BLCKL = 0	output black level = 24 IRE
		BLCKL = 63 (3FH)	output black level = 49 IRE
		white-to-sync = 143 IRE <sup>(2)</sup>	
		BLCKL = 0	output black level = 24 IRE
		BLCKL = 63 (3FH)	output black level = 50 IRE

#### Notes

- 1. Output black level/IRE = BLCKL × 25/63 + 24; recommended value: BLCKL = 60 (3CH) normal.
- 2. Output black level/IRE = BLCKL × 26/63 + 24; recommended value: BLCKL = 45 (2DH) normal.

#### Table 13 Subaddress 5E

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
BLNNL	variable blanking level	white-to-sync = 140 IRE <sup>(1)</sup>	
		BLNNL = 0	output blanking level = 17 IRE
		BLNNL = 63 (3FH)	output blanking level = 42 IRE
		white-to-sync = 143 IRE <sup>(2)</sup>	
		BLNNL = 0	output blanking level = 17 IRE
		BLNNL = 63 (3FH)	output blanking level = 43 IRE

#### Notes

- 1. Output black level/IRE = BLNNL × 25/63 + 17; recommended value: BLNNL = 58 (3AH) normal.
- 2. Output black level/IRE = BLNNL × 26/63 + 17; recommended value: BLNNL = 63 (3FH) normal.

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#### Table 14 Subaddress 60 (CCRS; select cross colour reduction filter in luminance)

DATA	BYTE	FUNCTION	
CCRS1	CCRS0	FUNCTION	
0	0	no cross colour reduction (for overall transfer characteristic of luminance see Fig.5)	
0	1	cross colour reduction #1 active (for overall transfer characteristic see Fig.5)	
1	0	cross colour reduction #2 active (for overall transfer characteristic see Fig.5)	
1	1	cross colour reduction #3 active (for overall transfer characteristic see Fig.5)	

#### Table 15 Subaddress 61

DATA BYTE	LOGIC LEVEL	DESCRIPTION
FISE	0	864 total pixel clocks per line
	1	858 total pixel clocks per line; default after reset
PAL	0	NTSC encoding (non-alternating V component); default after reset
	1	PAL encoding (alternating V component)
SCBW	0	enlarged bandwidth for chrominance encoding (for overall transfer characteristic of chrominance in baseband representation see Figs 3 and 4)
	1	standard bandwidth for chrominance encoding (for overall transfer characteristic of chrominance in baseband representation see Figs 3 and 4); default after reset
RTCE 0		no real time control of generated subcarrier frequency; default after reset
	1	real time control of generated subcarrier frequency through SAA7151B (timing see Fig.9)
YGS 0 luminance gain for white – black 100 IRE		luminance gain for white – black 100 IRE
	1 Iuminance gain for white – black 92.5 IRE including 7.5 IRE set-up of blac after reset	
INPI	0	PAL switch phase is nominal; default after reset
	1	PAL switch phase is inverted compared to nominal
DOWN	0	DACs in normal operational mode (not defined after reset, program after all zero-bits are set to zero)
	1	DACs forced to lowest output voltage (not defined after reset, program after all zero-bits are set to zero)

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#### Table 16 Subaddress 62

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
BSTA	amplitude of colour burst; input representation	white-to-black = 92.5 IRE; burst = 40 IRE; NTSC encoding	
	accordance with	BSTA = 0 to $1.25 \times nominal^{(1)}$	
	CCIR 601	white-to-black = 92.5 IRE; burst = 40 IRE; PAL encoding	
		BSTA = 0 to $1.76 \times \text{nominal}^{(2)}$	
		white-to-black = 100 IRE; burst = 43 IRE; NTSC encoding	
		BSTA = 0 to $1.20 \times \text{nominal}^{(3)}$	
		white-to-black = 100 IRE; burst = 43 IRE; PAL encoding	
		BSTA = 0 to $1.67 \times nominal^{(4)}$	
SQP	subcarrier real time	logic 0	control from SAA7151B digital colour decoder
		logic 1	not supported in current version, do not use

#### Notes

- 1. Recommended value: BSTA = 102 (66H).
- 2. Recommended value: BSTA = 72 (48H).
- 3. Recommended value: BSTA = 106 (6AH).
- 4. Recommended value: BSTA = 75 (4BH).

 Table 17
 Subaddress 63 to 66 (four bytes to program subcarrier frequency)

DATA BYTE	DESCRIPTION	CONDITIONS	REMARKS
FSC0 to FSC3	$f_{fsc} = subcarrier frequency$ (in multiples of line frequency); $f_{IIc} = clock frequency (in multiples of line frequency)$	$FSC = round\left(\frac{f_{fsc}}{f_{IIc}} \times 2^{32}\right)$ see note 1	FSC3 = most significant byte FSC0 = least significant byte

#### Notes

- 1. Examples:
  - a) NTSC-M:  $f_{fsc}$  = 227.5 MHz,  $f_{IIc}$  = 1716 MHz  $\rightarrow$  FSC = 569408543 (21F07C1FH).
  - b) PAL-B/G:  $f_{fsc}$  = 283.7516 MHz,  $f_{IIc}$  = 1728 MHz  $\rightarrow$  FSC = 705268427 (2A098ACBH).

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#### Table 18 Subaddress 67 to 6A

DATA BYTE <sup>(1)</sup>	DESCRIPTION		
L21O0	first byte of captioning data, odd field		
L21O1	econd byte of captioning data, odd field		
L21E0	rst byte of extended data, even field		
L21E1	second byte of extended data, even field		

#### Note

1. LSBs of the respective bytes are encoded immediately after run-in and framing code, the MSBs of the respective bytes have to carry the parity bit, in accordance with the definition of line 21 encoding format.

#### Table 19 Subaddress 6B

DATA BYTE	DESCRIPTION
SCCLN	selects the actual line, where closed caption or extended data are encoded; see note 1
MODIN	defines video data of MP port or VP(DP) port to be encoded; see Table 20

#### Note

1. Line = (SCCLN + 4) for M systems; line = (SCCLN + 1) for other systems.

#### Table 20 Logic levels and function of MODIN

DATA BYTE		FUNCTION	
MODIN1	MODIN0	FUNCTION	
0	0	unconditionally from MP port	
0	1	from MP port, if pin SEL_ED = HIGH; otherwise from VP port	
1	0	unconditionally from VP port	
1	1	from VP port, if pin SEL_ED = HIGH; otherwise from MP port	

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DATA BYTE	LOGIC LEVEL	DESCRIPTION
PRCV2	0	polarity of RCV2 as output is active HIGH, rising edge is taken when input, respectively; default after reset
	1	polarity of RCV2 as output is active LOW, falling edge is taken when input, respectively
ORCV2	0	pin RCV2 is switched to input; default after reset
	1	pin RCV2 is switched to output
CBLF	0	if ORCV2 = HIGH, pin RCV2 provides an HREF signal (Horizontal Reference Pulse that is HIGH during active portion of line, also during vertical blanking Interval); default after reset
	1	if ORCV2 = LOW, signal input to RCV2 is used for horizontal synchronization only (if TRCV2 = 1); default after reset
		if ORCV2 = LOW, signal input to RCV2 is used for horizontal synchronization (if TRCV2 = 1) also as an internal blanking signal
PRCV1	0	polarity of RCV1 as output is active HIGH, rising edge is taken when input, respectively; default after reset
	1	polarity of RCV1 as output is active LOW, falling edge is taken when input, respectively
ORCV1	0	pin RCV1 is switched to input; default after reset
	1	pin RCV1 is switched to output
TRCV2	0	horizontal synchronization is taken from RCV1 port; default after reset
	1	horizontal synchronization is taken from RCV2 port
SRCV1	_	defines signal type on pin RCV1; see Table 22

#### Table 22 Logic levels and function of SRCV1

DATA	DATA BYTE			FUNCTION
SRCV11	SRCV10	AS OUTPUT	AS INPUT	FUNCTION
0	0	VS	VS	Vertical Sync each field; default after reset
0	1	FS	FS	Frame Sync (odd/even)
1	0	FSEQ	FSEQ	Field Sequence, vertical sync every fourth field (FISE = 1) or eighth field (FISE = 0)
1	1	-	_	not applicable

#### Table 23 Subaddress 6D

DATA BYTE	DESCRIPTION	
CCEN	enables individual line 21 encoding; see Table 24	
SRCM	defines signal type on pin RCM1; see Table 25	

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Table 24 Logic levels and function of CCEN

DATA BYTE		EUNCTION	
CCEN1	CCEN0	FUNCTION	
0	0	line 21 encoding OFF	
0	1	enables encoding in field 1 (odd)	
1	0	enables encoding in field 2 (even)	
1	1	enables encoding in both fields	

#### Table 25 Logic levels and function of SRCM

DATA	DATA BYTE		FUNCTION
SRCM1	SRCM0	AS OUTPUT	FUNCTION
0	0	VS	Vertical Sync each field
0	1	FS	Frame Sync (odd/even)
1	0	FSEQ	Field Sequence, vertical sync every fourth field (FISE = 1) or eighth field (FISE = 0)
1	1	_	not applicable

#### Table 26 Subaddress 6E to 6F

DATA BYTE	DESCRIPTION
HTRIG	sets the Horizontal Trigger phase related to signal on RCV1 or RCV2 input
	values above 1715 (FISE = 1) or 1727 (FISE = 0) are not allowed
	increasing HTRIG decreases delays of all internally generated timing signals
	reference mark: analog output horizontal sync (leading slope) coincides with active edge of RCV used for triggering at HTRIG = 032H

#### Table 27 Subaddress 70

DATA BYTE	LOGIC LEVEL	DESCRIPTION	
VTRIG	_	sets the Vertical TRIGger phase related to signal on RCV1 input	
		increasing VTRIG decreases delays of all internally generated timing signals, measured in half lines	
		variation range of VTRIG = 0 to 31 (1FH)	
SBLBN	0	vertical blanking is defined by programming of FAL and LAL	
	1	vertical blanking is forced automatically at least during field synchronization and equalization pulses; note 1	
PHRES	_	selects the phase reset mode of the colour subcarrier generator; see Table 28	

#### Note

1. If cross-colour reduction is programmed, it is active between FAL and LAL in both events.

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#### Table 28 Logic levels and function of PHRES

DATA BYTE		FUNCTION	
PHRES1	PHRES0	FUNCTION	
0	0	no reset	
0	1	reset every two lines	
1	0	reset every eight fields	
1	1	reset every four fields	

#### Table 29Subaddress 71 to 73

DATA BYTE	DESCRIPTION			
BMRQ	peginning of MP ReQuest signal (RCM2)			
	values above 1715 (FISE = 1) or 1727 (FISE = 0) are not allowed			
	first active pixel at analog outputs (corresponding input pixel coinciding with RCM2) at BMRQ = 0F9H (115H)			
EMRQ	end of MP ReQuest signal (RCM2)			
	values above 1715 (FISE = 1) or 1727 (FISE = 0) are not allowed			
	last active pixel at analog outputs (corresponding input pixel coinciding with RCM2) at EMRQ = 686H (690H)			

#### Table 30Subaddress 77 to 79

DATA BYTE	DESCRIPTION
BRCV	beginning of output signal on RCV2 pin values above 1715 (FISE = 1) or 1727 (FISE = 0) are not allowed
	first active pixel at analog outputs (corresponding input pixel coinciding with RCV2) at BRCV = 0F9H (115H)
ERCV	end of output signal on RCV2 pin values above 1715 (FISE = 1) or 1727 (FISE = 0) are not allowed
	last active pixel at analog outputs (corresponding input pixel coinciding with RCV2) at ERCV = 686H (690H)

#### Table 31 Subaddress 7A to 7D

DATA BYTE	DESCRIPTION
FLEN	Length of a Field = FLEN + 1, measured in half lines
	valid range is limited to 524 to 1022 (FISE = 1) respectively 624 to 1022 (FISE = 0), FLEN should be even
FAL	First Active Line after vertical blanking interval = FAL + 1, measured in lines
	FAL = 0 coincides with the first field synchronization pulse
LAL	Last Active Line before vertical blanking interval = LAL + 1, measured in lines
	LAL = 0 coincides with the first field synchronization pulse

#### SUBADDRESSES

In subaddresses 5B, 5C, 5D, 5E and 62 all IRE values are rounded up.

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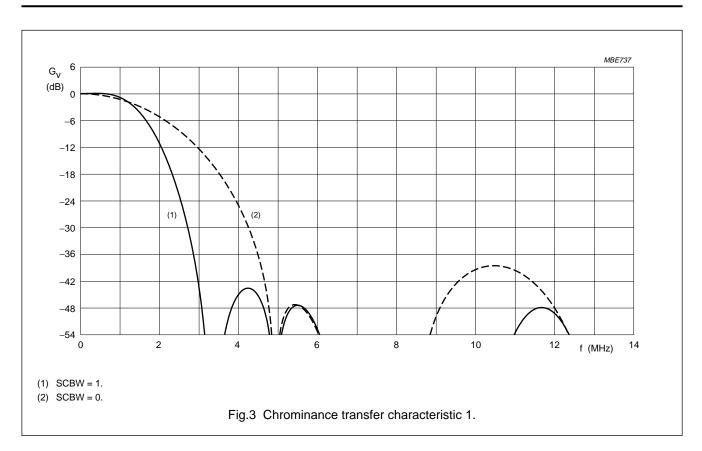
Slave Transmitter

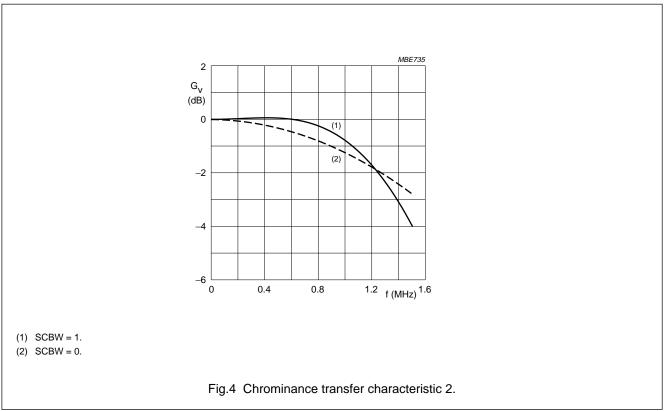
Table 32 Slave Transmitter (slave address 89H or 8DH)

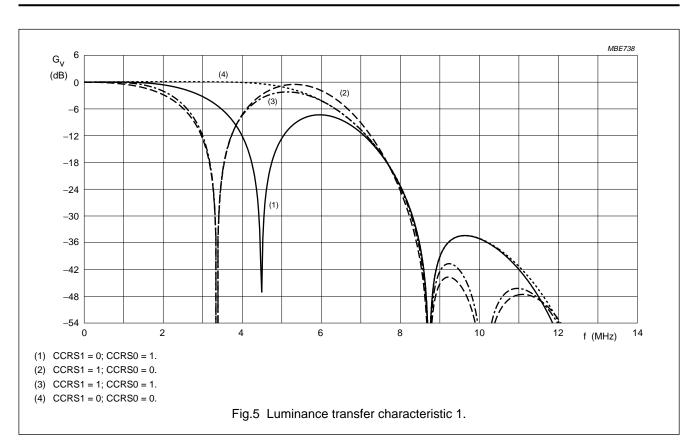
	SUBADDRESS				DATA	BYTE			
FUNCTION	SUBADDRESS	D7	D6	D5	D4	D3	D2	D1	D0
Status byte	_	VER2	VER1	VER0	CCRDE	CCRDO	FSQ2	FSQ1	FSQ0

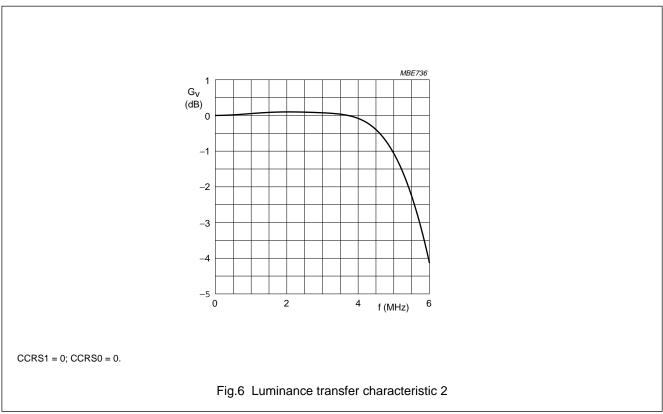
#### Table 33 No subaddress

DATA BYTE	DESCRIPTION
VER	Version identification of the device. It will be changed with all versions of the IC that have different programming models. Current Version is 000 binary.
CCRDE	Closed caption bytes of the even field have been encoded.
	The bit is reset after information has been written to the subaddresses 69 and 6A. It is set immediately after the data have been encoded.
CCRDO	Closed caption bytes of the odd field have been encoded.
	The bit is reset after information has been written to the subaddresses 67 and 68. It is set immediately after the data have been encoded.
FSQ	State of the internal field sequence counter.
	Bit 0 (FSQ0) gives the odd/even information; odd = LOW, even = HIGH.









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#### CHARACTERISTICS

 $V_{DDD}$  = 4.5 to 5.5 V;  $T_{amb}$  = 0 to 70 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Supply		1	-		
V <sub>DDD</sub>	digital supply voltage		4.5	5.5	V
V <sub>DDA</sub>	analog supply voltage		4.75	5.25	V
I <sub>DDD</sub>	digital supply current	note 1	-	170	mA
I <sub>DDA</sub>	analog supply current	note 1	-	55	mA
Inputs		•	•	•	
V <sub>IL</sub>	LOW level input voltage (except LLC, SDA, SCL, AP, SP and XTALI)		-0.5	+0.8	V
V <sub>IH</sub>	HIGH level input voltage (except LLC, SDA, SCL, AP, SP and XTALI)		2.0	V <sub>DDD</sub> + 0.5	V
	HIGH level input voltage (LLC)		2.4	V <sub>DDD</sub> + 0.5	V
V <sub>LI</sub>	input leakage current		-	1	μA
CI	input capacitance	clocks operating	-	10	pF
		data available	-	8	pF
		I/Os at high impedance	_	8	pF
Outputs					
V <sub>OL</sub>	LOW level output voltage (except SDA and XTALO)	note 2	0	0.6	V
V <sub>OH</sub>	HIGH level output voltage (except LLC, SDA, DTACK and XTALO)	note 2	2.4	V <sub>DDD</sub> + 0.5	V
	HIGH level output voltage (LLC)	note 2	2.6	V <sub>DDD</sub> + 0.5	V
I <sup>2</sup> C-bus; SI	DA and SCL				
VIL	LOW level input voltage		-0.5	+1.5	V
V <sub>IH</sub>	HIGH level input voltage		3.0	V <sub>DDD</sub> + 0.5	V
l <sub>l</sub>	input current	V <sub>I</sub> = LOW or HIGH	-10	+10	μA
V <sub>OL</sub>	LOW level output voltage (SDA)	I <sub>OL</sub> = 3 mA	-	0.4	V
I <sub>O</sub>	output current	during acknowledge	3	_	mA
Clock timi	ng (LLC)				
T <sub>LLC</sub>	cycle time	note 3	34	41	ns
δ	duty factor t <sub>HIGH</sub> /T <sub>LLC</sub>	note 4	40	60	%
t <sub>r</sub>	rise time	note 3	-	5	ns
t <sub>f</sub>	fall time	note 3	_	6	ns

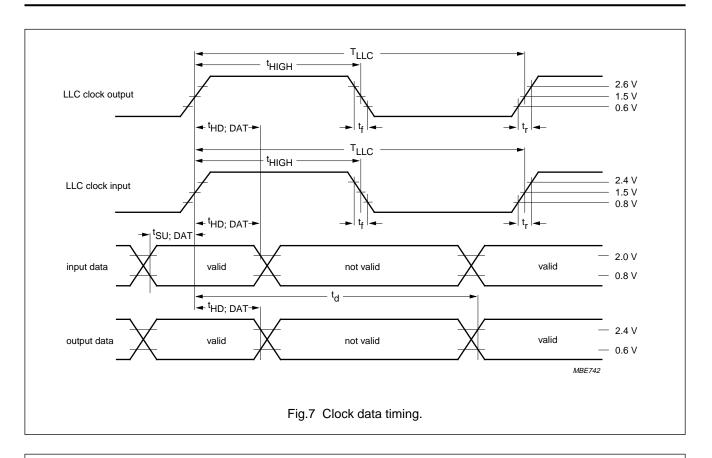
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Input timin	lg	1	-!	1	
t <sub>SU;CREF</sub>	input data set-up time (C <sub>ref</sub> )		6	_	ns
t <sub>HD;CREF</sub>	input data hold time (C <sub>ref</sub> )		3	_	ns
t <sub>SU</sub>	input data set-up time (any other except SEL_MPU, CDIR, RW/SCL, A0/SDA, CS/SA, RESET, AP and SP)		6	-	ns
t <sub>HD</sub>	input data hold time (any other except SEL_MPU, CDIR, RW/SCL, A0/SDA, CS/SA, RESET, AP and SP)		3	-	ns
Crystal os	cillator				
f <sub>n</sub>	nominal frequency (usually 27 MHz)	3rd harmonic	_	30	MHz
$\Delta f/f_n$	permissible deviation of nominal frequency	note 5	-50	+50	10 <sup>-6</sup>
CRYSTAL SF	PECIFICATION			1	
T <sub>amb</sub>	operating ambient temperature		0	70	°C
CL	load capacitance		8	-	pF
R <sub>S</sub>	series resistance		_	80	Ω
C <sub>1</sub>	motional capacitance (typical)		1.5 –20%	1.5 +20%	fF
C <sub>0</sub>	parallel capacitance (typical)		3.5 –20%	3.5 +20%	pF
MPU interf	ace timing				
t <sub>AS</sub>	address set-up time	note 6	9	-	ns
t <sub>AH</sub>	address hold time		0	-	ns
t <sub>RWS</sub>	read/write set-up time	note 6	9	-	ns
t <sub>R₩H</sub>	read/write hold time		0	-	ns
t <sub>DD</sub>	data bus floating from $\overline{CS}$ (read)	notes 7, 8 and 9; n = 9	_	400	ns
t <sub>DF</sub>	data valid from $\overline{CS}$ (read)	notes 7 and 8; n = 5	_	255	ns
t <sub>DS</sub>	data bus set-up time (write)	note 6	9	-	ns
t <sub>DH</sub>	data bus hold time (write)	note 6	9	-	ns
t <sub>ACS</sub>	acknowledge delay from $\overline{CS}$	notes 7 and 8; n = 11	_	475	ns
t <sub>CSD</sub>	CS HIGH from acknowledge		0	-	ns
t <sub>DAT</sub>	DTACK floating from CS HIGH	notes 7 and 8; n = 7	_	330	ns
Data and r	eference signal output timing				
CL	output load capacitance		7.5	40	pF
t <sub>OH</sub>	output hold time		4	-	ns
t <sub>OD</sub>	output delay time	C <sub>ref</sub> in output mode	_	25	ns

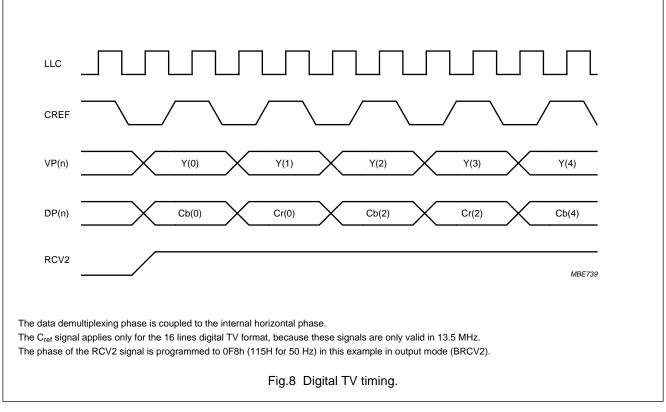
### SAA7185

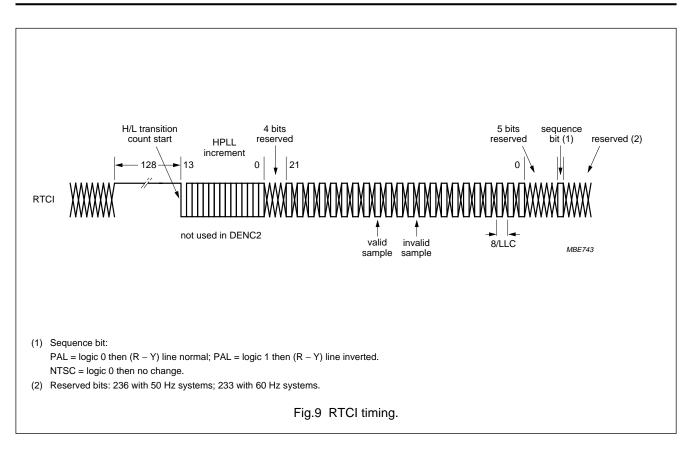
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
CHROMA,	Y and CVBS outputs	•	•	•	
V <sub>o(p-p)</sub>	output signal voltage (peak-to-peak value)	note 10	1.9	2.1	V
R <sub>I</sub>	internal serial resistance		18	35	Ω
RL	output load resistance		80	-	Ω
В	output signal bandwidth of DACs	-3 dB	10	-	MHz
ILE	LF integral linearity error of DACs		-	±2	LSB
DLE	LF differential linearity error of DACs		-	±1	LSB

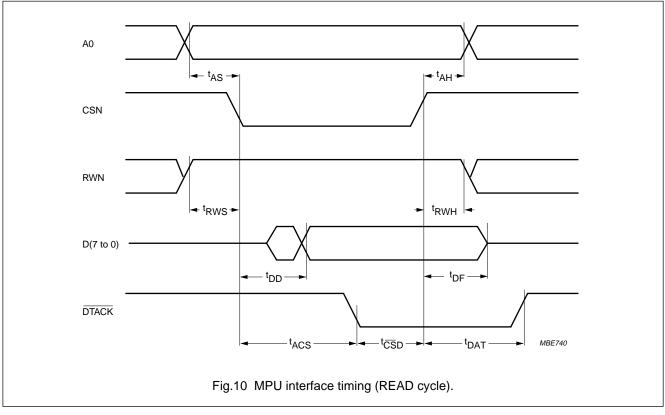
#### Notes

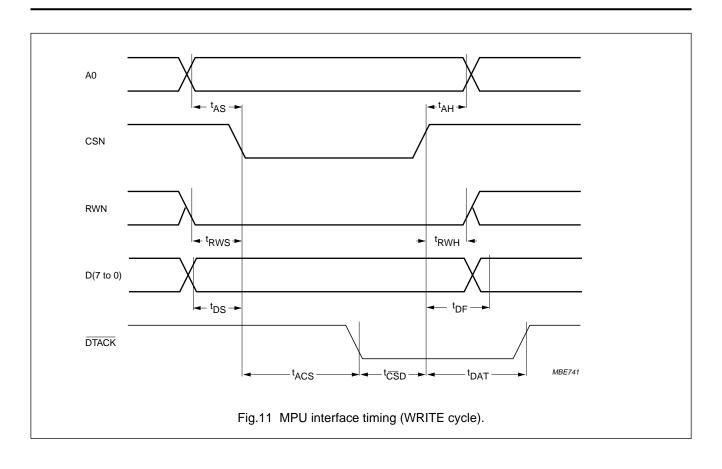
- 1. At maximum supply voltage with highly active input signals.
- 2. The levels have to be measured with load circuits of 1.2 k $\Omega$  to 3.0 V (standard TTL load) and C<sub>L</sub> = 25 pF.
- 3. The data is for both input and output direction.
- 4. With LLC in input mode. In output mode, with a crystal connected to XTALO/XTALI duty factor is typically 50%.
- 5. If an internal oscillator is used, crystal deviation of nominal frequency is directly proportional to the deviation of subcarrier frequency and line/field frequency.
- 6. The value is calculated via equation  $t = t_{SU} + t_{HD}$
- 7. The value depends on the clock frequency. The numbers given are calculated with  $f_{LLC} = 27$  MHz.
- 8. The values given are calculated via equation  $t_{dmax} = t_{OD} + n \times t_{LLC} + t_{SU}$
- 9. The falling edge of  $\overline{\text{DTACK}}$  will always occur1 × LLC after data is valid.
- 10. For full digital range, without load, V<sub>DDA</sub> = 5.0 V. The typical voltage swing is 2.0 V, the typical minimum output voltage (digital zero at DAC) is 0.2 V.



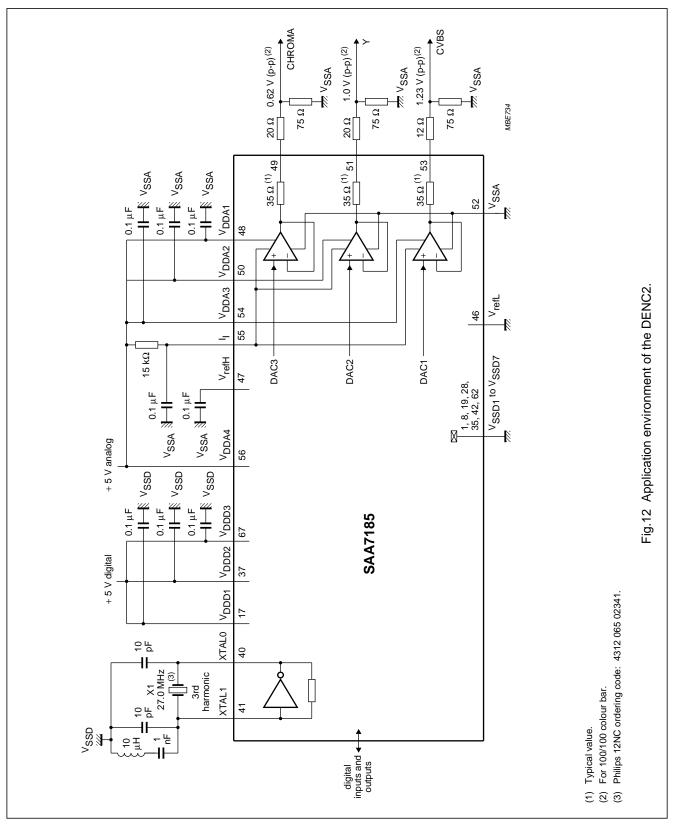








#### **APPLICATION INFORMATION**

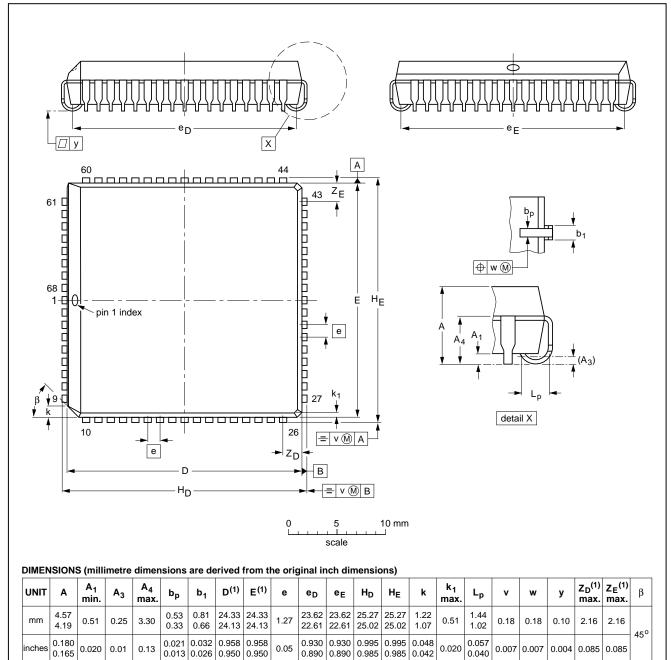


## SAA7185

SOT188-2

#### PACKAGE OUTLINE

#### PLCC68: plastic leaded chip carrier; 68 leads



#### Note

inches

0.165

0.020 0.01

1. Plastic or metal protrusions of 0.01 inches maximum per side are not included.

0.13

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1350E DATE
SOT188-2	112E10	MO-047AC				<del>92-11-17</del> 95-03-11

0.890 0.890 0.985

0.020

0.040

0.985 0.042

0.007 0.007

0.004 0.085 0.085

0.05

0.950

### SAA7185

#### SOLDERING

#### Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

#### **Reflow soldering**

Reflow soldering techniques are suitable for all PLCC packages.

The choice of heating method may be influenced by larger PLCC packages (44 leads, or more). If infrared or vapour phase heating is used and the large packages are not absolutely dry (less than 0.1% moisture content by weight), vaporization of the small amount of moisture in them can cause cracking of the plastic body. For more information, refer to the Drypack chapter in our "Quality Reference Handbook" (order code 9397 750 00192).

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

#### Wave soldering

Wave soldering techniques can be used for all PLCC packages if the following conditions are observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

#### **Repairing soldered joints**

Fix the component by first soldering two diagonallyopposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

### SAA7185

#### DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				
more of the limiting values of the device at these or at	accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or may cause permanent damage to the device. These are stress ratings only and operation any other conditions above those given in the Characteristics sections of the specification limiting values for extended periods may affect device reliability.			
Application information				
Where application information is given, it is advisory and does not form part of the specification.				

#### LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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Purchase of Philips I<sup>2</sup>C components conveys a license under the Philips' I<sup>2</sup>C patent to use the components in the I<sup>2</sup>C system provided the system conforms to the I<sup>2</sup>C specification defined by Philips. This specification can be ordered using the code 9398 393 40011.

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NOTES

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